Financial Briefings for the Second Quarter of the Fiscal Year Ending March 2024 (April to September 2023)

November 9, 2023
KOKUSAI ELECTRIC CORPORATION

Disclaimers

This document and the information presented in this document were created for the purpose of disclosing corporate information, etc., and do not constitute a solicitation of an offer to subscribe for shares or other securities of the Company, either domestically or internationally.

■ Forward-Looking Statements

The Group's business plans and forecasts stated in this document are prepared by the Group based on information available at the time of preparation and do not guarantee future results or performance. Actual business results and performance may differ significantly from the plans and forecasts due to changes in various internal and external factors. The Company does not undertake any obligation to update or revise any information contained in this document based on future events, except as required by applicable laws or stock exchange rules. The key risks that may significantly affect the Group's business results, financial position and cash flows are stated in the annual securities report of the Company.

■ Currency Risk

The Group has a high proportion of overseas revenue. In addition, the valuation of the Group's foreign currency-denominated assets and liabilities is affected by fluctuations of the foreign exchange market, but the export sales of the Company's products are mostly reported in Japanese yen. Some sales and expenses are reported in foreign currencies, but the impact on profit is minimal unless there are extreme fluctuations in the exchange rates.

Key Performance Indicators

To understand the trends in business results to improve corporate value, the Group uses Adjusted Operating Profit and Adjusted (quarterly) Net Income as key performance indicators. The calculation methods are stated in the earnings report.

Accounting Standard

The Company prepares its consolidated financial reports based in accordance with International Financial Reporting Standards (IFRS) since FY2021/3.

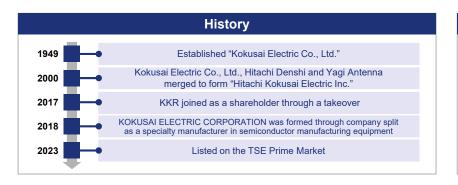
Rounding Convention

Except in certain cases, amounts presented in this document have been rounded to the nearest hundredth million, and accordingly the sum of the amounts may not be equal to the total of the individual items.

About the KOKUSAI ELECTRIC Group

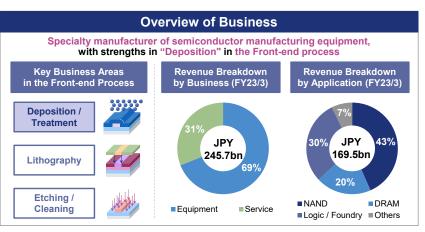


KOKUSAI ELECTRIC at a Glance



Overview of Financials (FY23/3)						
Revenue	Gross Profit Margin	Adjusted Operating Profit Margin				
JPY 245.7 bn	41.0%	26.1 %				
CAGR of Revenue						
(FY18/3 – FY23/3)	Adjusted ROE	Equity Ratio				
12.9%	28.6%	43.5%				

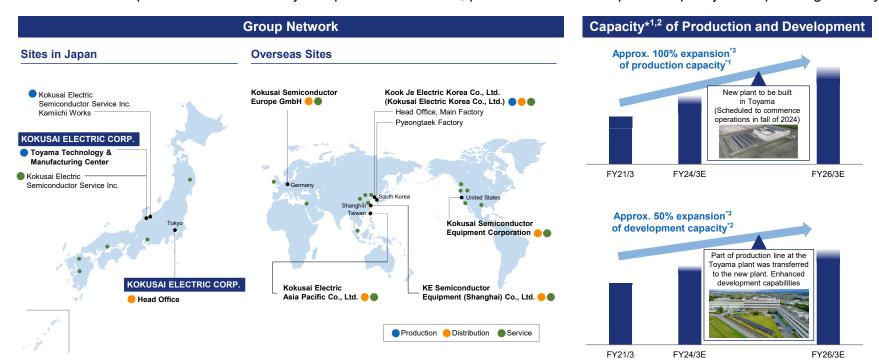
01	verview of Compan	y
Company Name	KOKUSAI ELECTRIC O	CORPORATION
Category of Industry	Electric Appliances	
Securities Code	6525	
Fiscal Year Ending	March 31	
Representative Director	Fumiyuki Kanai	
Financial Accounting Standards	International Financial F	Reporting Standards (IFRS)
Number of Employees*1	Consolidated: 2,473, No	on-consolidated: 1,129
Number of shares per unit	100	
Recent Awards		
Intel EPIC	(D.851)	4330 CEL
Intel EPIC Distinguished Supplier Award 2023	TechInsights 10 BEST Suppliers 2023	TSMC 2022 Excellent Performance Award



Business Sites

Owns manufacturing sites in Toyama and South Korea, and business sites in Asia, China, the United States, and Europe.

With the start of operations at the new Toyama plant in fall of 2024, production and development capacity will expand significantly.



^{*1} Max. production volume per month *2 No. of evaluation equipment *3 In comparison to FY21/3

Mid- to Long-Term Management Policy

Based on the "KOKUSAI ELECTRIC Way" (corporate philosophy), pursue economic value and environmental and social value from both aspects of business activities and ESG initiatives, contribute to the achievement of SDGs, and continue to support a future where creation and innovation are born.

"KOKUSAI ELECTRIC Way" KOKUSAI ELECTRIC Way **Technology & Tai-wa** for Tomorrow The KOKUSAI ELECTRIC Group supports a future where creativity and innovation are born out of Technology and Tai-wa. Purpose Your Trusted Partner To Bring Vision **Technology Dreams to Life Our Technology** Value / Mission Refine technology ■ Create technology Advance technology Materiality Captivate with technology Our Tai-wa ■ Tai-wa with cutting edge technology ■ Tai-wa with the natural environment ■ Tai-wa with social issues

KOKUSAI ELECTRIC

Tai-wa with ourselves

Sustainability management

Contribute to the realization of a sustainable society and the achievement of SDGs





















Business activities

Environmental & Social activities

Strengthening governance

Our Business and Major Products

Business Profile and Revenue Breakdown (FY23/3)

Equipment (69%)

Batch Deposition

Batch ALD

Worldwide Market Share No. 1 (CY2022)*1

- Batch deposition equipment that can process dozens or more wafers at once and compatible to ALD technology. Due to semiconductor devices becoming more complex, demand for more difficult and high-quality deposition has expanded the need for ALD.
- ALD is abbreviation for Atomic Layer Deposition. We refer to a technique for thin-film deposition at an atomic layer level involving a process of cyclical supply of multiple gases as "ALD."

Batch CVD

 CVD is abbreviation for Chemical Vapor Deposition. Multiple gases are simultaneously flowed into a chamber, react in the gas phase. We mainly focus on Low Pressure CVD.

Service (31%)

- After-sales service for semiconductor manufacturing equipment sold by our group. ("Parts Sales", "Maintenance", "Repair", "Moving and Modifying Equipment" and "Legacy Equipment Sales")
- In Parts Sales and Maintenance, steady > around 10% YoY growth of installed base in FY17/3-FY23/3, contributing to stable and recurring service revenue growth.
- With "Design for Service Business" concept, we aim to provide higher value-added services.









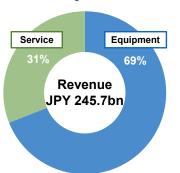


Treatment

Worldwide Market Share

No.2 (CY2022)*2

- Treatment equipment improves film properties by applying plasma and heat on thin film to remove impurities from film and stabilize particles.
- As semiconductor devices have become more complex in recent years, demand has grown for treatment with excellent isotropy and step coverage.
- Demand for treatment in low-temperature environments has grown as well.



Major Products

Large batch deposition "AdvancedAce®-300"



- Achieved high productivity and high quality deposition.
- Compatible with technology including batch ALD, batch CVD, oxidation, diffusion and steady annealing.

Mini batch deposition "TSURUGI-C^{2®} 剱[®]"



- Capable of both highly difficult deposition and high productivity on next-generation devices.
- Compatible with thin film formation processes such as the latest batch ALD technology.

Single-wafer treatment "MARORA®"



- Improves film properties by applying plasma and heat.
- Able to treat complex semiconductor shapes with high productivity and quality.

Single-wafer treatment "TANDUO®"



- Improves film properties by applying heat on thin film.
- Capable of annealing in low temperature.

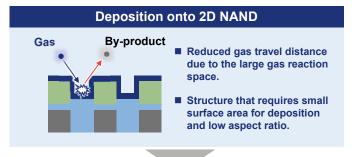
^{*1} We classified and described by business because the Group has a single segment. *2 Source: Techlnsights Manufacturing Analysis Inc. (VLSI) "TI_ALD Tools_YEARLY" 2023 (April)

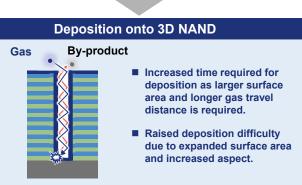
^{*3} We define "RTP and Oxidation / Diffusion" by Gartner's WFE segment as "Treatment", Source: "Market Share Semiconductor Wafer Fab Equipment, Worldwide, 2022, Bob Johnson et al., published April 17, 2023"

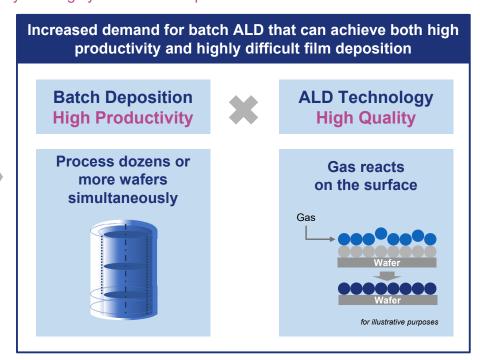
Batch Deposition Equipment: Accelerating Batch ALD Demand

As devices become more complex, productivity challenges have become more apparent and highly difficult film deposition turned critical.

Batch ALD is the optimal solution combining high productivity with highly difficult film deposition.



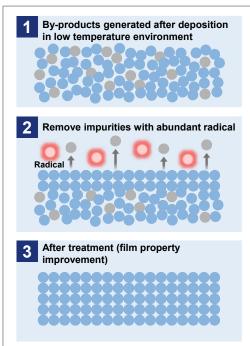


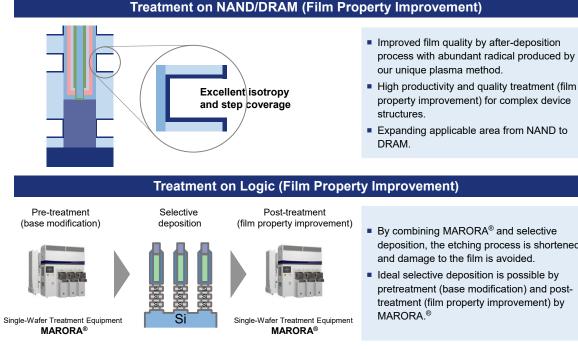


Treatment Equipment: Demand Expanding as well

Treatment (film property improvement) in a wide range of temperatures by plasma and heating is possible.

A solution that achieves high productivity with excellent isotropy and step coverage.





process with abundant radical produced by

property improvement) for complex device

deposition, the etching process is shortened

pretreatment (base modification) and posttreatment (film property improvement) by

and damage to the film is avoided.

our unique plasma method.

structures.

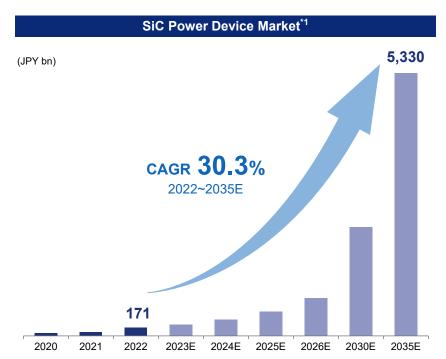
MARORA.®

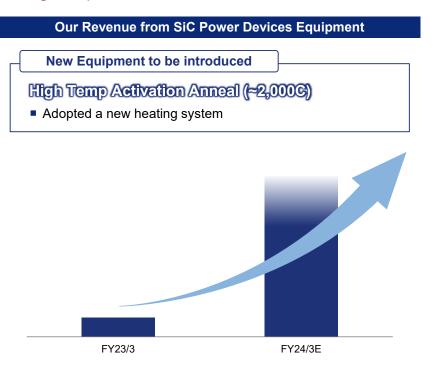
DRAM.

Service Business: Rapid Expansion of SiC Power Device Equipment

Sales of 150/200mm equipment for SiC power devices have increased.

We aim to further expand the business by launching new products of high-temp anneal.





^{*1} FUJI KEIZAI CO., LTD. "2023 Current status and future outlook of markets for power devices and power electronics-related equipment"





Highlight

Consolidated Results for 2Q FY24/3

- Semiconductor devices inventory adjustments are progressing, and the market bottomed out. Some semiconductor device manufacturers continue to restrain investment.
- Our 1H results saw a decrease in revenue and profits, but 2Q results improved significantly QoQ.

Consolidated Earnings Forecast for FY24/3

■ 1Q was sluggish; recovery expected to start in 2Q with further rebound anticipated in 3Q and 4Q. Robust investment for mature nodes to support our revenue. No changes to the previous forecast.

Medium- to Long-term Business Strategies and Objectives

■ We continue R&D investment and Capex for medium- to long-term growth, to respond to the changes in the market environment and customer needs and further expand our business.

Consolidated Results Summary

The decrease in revenue and profit continued from 1Q, affected by the restrained investment by semiconductor device manufacturers. However, 2Q results improved significantly QoQ.

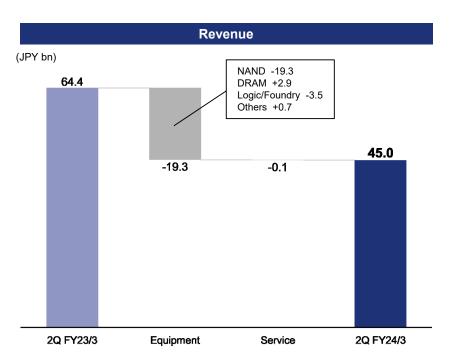
Gross profit margin improved to 44.0% for 1H.

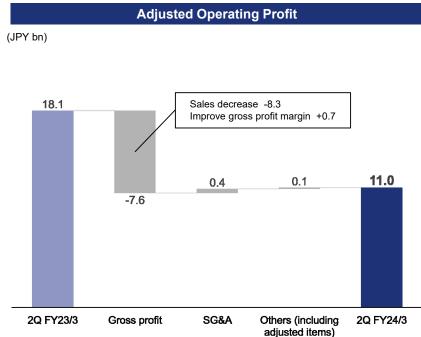
	FY23/3			FY24/3					
(JPY bn)	1Q	2Q	1H	1Q	2Q	YoY	QoQ	1H	YoY
Revenue	56.0	64.4	120.4	32.7	45.0	-30.1%	+37.6%	77.7	-35.5%
Gross profit	23.1	27.5	50.6	14.3	19.9	-27.6%	+39.3%	34.2	-32.5%
Gross profit margin	41.2%	42.7%	42.0%	43.6%	44.2%	+1.5pts	+0.6pts	44.0%	+2.0pts
Adjusted operating profit	14.7	18.1	32.8	5.6	11.0	-39.0%	+96.6%	16.6	-49.2%
Adjusted operating profit margin	26.2%	28.1%	27.2%	17.2%	24.5%	-3.6pts	+7.3pts	21.4%	-5.8pts
Adjusted net income	10.8	12.5	23.3	3.8	7.3	-41.4%	+93.1%	11.1	-52.4%
Adjusted net income margin	19.3%	19.4%	19.3%	11.6%	16.2%	-3.2pts	+4.6pts	14.3%	-5.0pts
Operating profit	13.0	16.4	29.4	4.0	9.4	-42.8%	+135.2%	13.4	-54.5%
Operating profit margin	23.2%	25.5%	24.4%	12.2%	20.9%	-4.6pts	+8.7pts	17.2%	-7.2pts
Income before income tax	12.9	16.4	29.3	3.7	9.1	-44.3%	+145.4%	12.9	-56.1%
Income before income tax margin	23.0%	25.5%	24.4%	11.4%	20.3%	-5.2pts	+8.9pts	16.6%	-7.8pts
Net income	9.6	11.3	20.9	2.7	6.2	-45.5%	+131.9%	8.8	-57.8%
Net income margin	17.1%	17.5%	17.4%	8.1%	13.7%	-3.8pts	+5.6pts	11.3%	-6.1pts
R&D expenses	2.7	3.3	6.0	2.9	3.0	-8.2%	+3.1%	6.0	-0.4%
Capital expenditures	0.7	2.9	3.6	5.1	2.1	-27.4%	-59.2%	7.1	+99.2%
Depreciation & amortization	2.5	2.6	5.1	2.6	2.7	+4.2%	+1.3%	5.3	+4.2%

2Q FY2024/3 Results: Factors for Changes

Revenue decreased by JPY19.4 bn YoY due to a decline of equipment revenue from investment restraints by some device manufacturers.

A decline in equipment revenue led to a decrease in gross profit margin, with adjusted operating profit down JPY7.1 bn YoY.





Revenues by Business

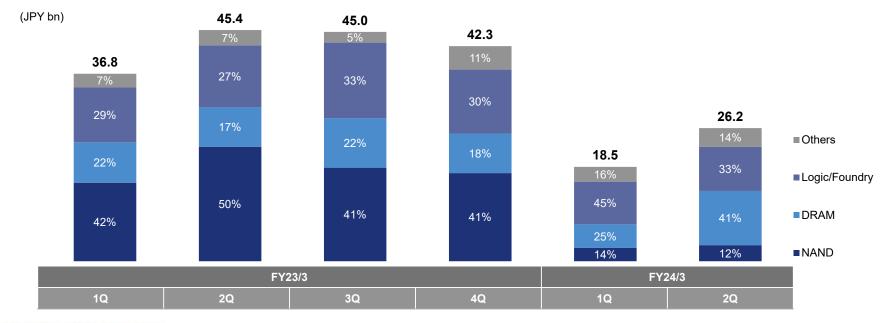
FY23/3 revenue composition by business consists of approx. 70% equipment and approx. 30% service.

For FY24/3, while equipment revenue is decreasing, the sales composition of service is increasing due to continued strong performance of service.



Revenues by Application (Equipment only)

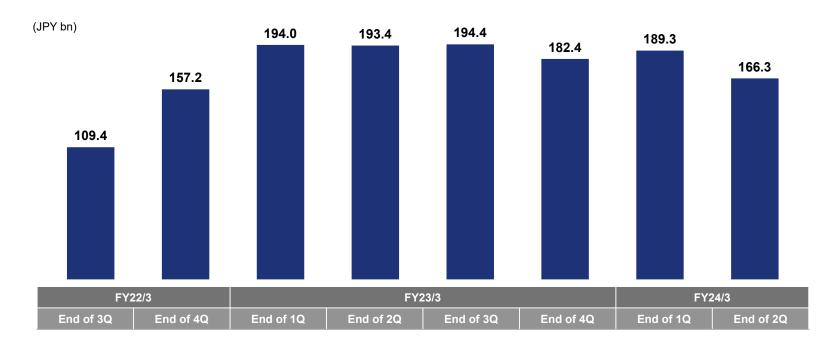
FY23/3 revenue composition by application consists of approx. 43% NAND, approx. 20% DRAM, approx. 37% Logic and others. For FY24/3, decrease in NAND revenue will result in increased revenue composition ratio for Logic and others.



Trends in Order Backlog

Long lead times projects have begun to turn into revenue, and the order backlog started to return to normal levels.

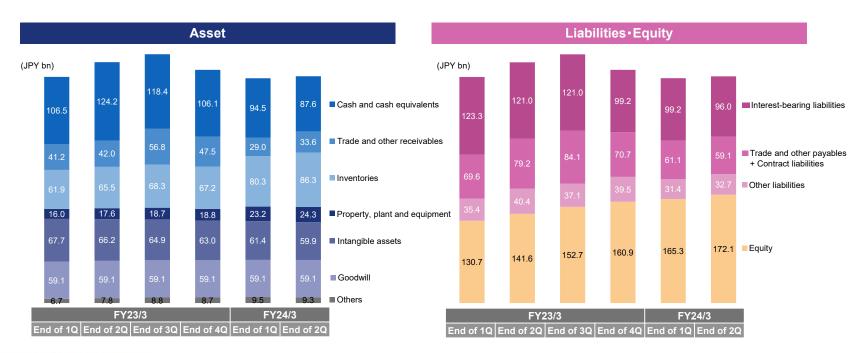
Fx%%jxzq1the order backlog decreased to JPY166.3 bn at the end of 2Q.



Balance Sheet

Total assets decreased by JPY10.2 bn from the end of FY23/3, mainly due to decreases in cash and cash equivalents, and trade and other receivables.

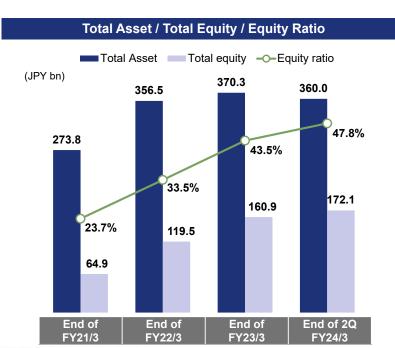
Total liabilities decreased by JPY21.5 bn from the end of FY23/3, mainly due to decrease in trade and other payables, etc.

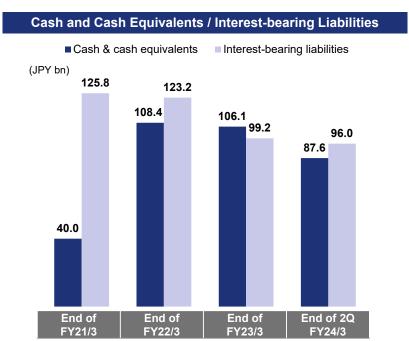


Equity Ratio / Cash and Cash Equivalents / Interest-bearing Liabilities

The equity ratio increased to 47.8% as of the end of 2Q.

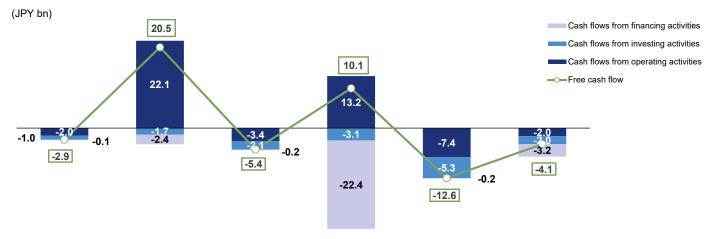
Interest-bearing liabilities has been decreasing, having achieved a net cash position as of the end of FY22/3. For FY24/3, operating cash flows have deteriorated temporarily, resulting in net debt of JPY8.5 bn as of the end of 2Q.





Cash Flows

For FY24/3, the decrease in trade and other payables and quarterly profits resulted in a decrease in operating cash flow. The balance of cash and cash equivalents remained high at the end of 2Q.

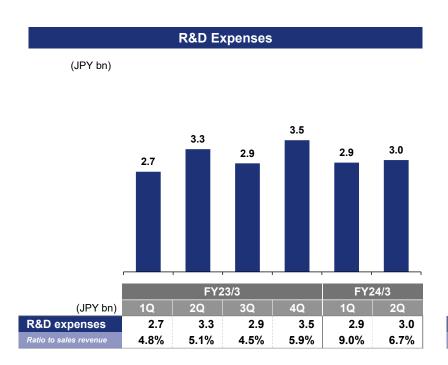


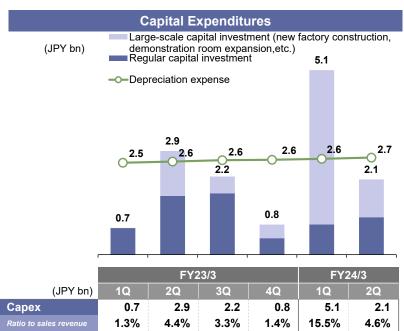
		F'	FY24	/3		
(JPY bn)	1Q	2Q	3Q	4Q	1Q	2Q
CF from operating activities	-2.0	22.1	-3.4	13.2	-7.4	-2.0
CF from investing activities	-1.0	-1.7	-2.1	-3.1	-5.3	-2.0
CF from financing activities	-0.1	-2.4	-0.2	-22.4	-0.2	-3.2
Free CF	-2.9	20.5	-5.4	10.1	-12.6	-4.1
Cash and cash equivalents	106.5	124.2	118.4	106.1	94.5	87.6

R&D Expenses / Capital Expenditure

R&D expenses are increasing gradually due to the investment in next-generation product development.

Capex has increased compared to previous terms due to new factory construction and demonstration room expansion.









Highlight

Consolidated Results for 2Q FY24/3

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- Our 1H results saw a decrease in revenue and profits, but 2Q results improved significantly QoQ.

Consolidated Earnings Forecast for FY24/3

■ 1Q was sluggish; recovery expected to start in 2Q with further rebound anticipated in 3Q and 4Q. Robust investment for mature nodes to support our revenue. No changes to the previous forecast.

Medium- to Long-term Business Strategies and Objectives

■ We continue R&D investment and Capex for medium- to long-term growth, to respond to the changes in the market environment and customer needs and further expand our business.

FY2024/3 Earnings Forecast

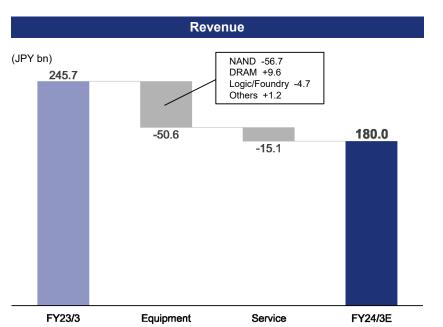
No changes to the previous forecast. Investments in mature nodes and DRAMs to support 2H earnings.

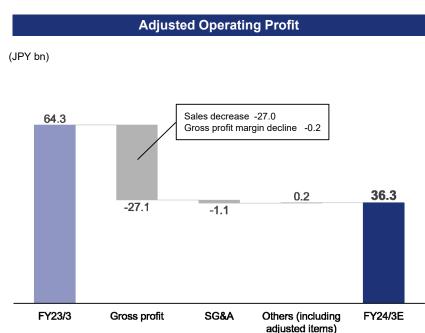
	FY23/3		FY24/3		
(JPY bn)	1H	Full year	1H	Full year	YoY
Revenue	120.4	245.7	77.7	180.0	-26.7%
Gross profit	50.6	100.8	34.2	73.7	-26.9%
Gross profit margin	42.0%	41.0%	44.0%	40.9%	-0.1pts
Adjusted operating profit	32.8	64.3	16.6	36.3	-43.6%
Adjusted operating profit margin	27.2%	26.1%	21.4%	20.1%	-6.0pts
Adjusted net income	23.3	46.0	11.1	25.2	-45.3%
Adjusted net income margin	19.3%	18.7%	14.3%	14.0%	-4.7pts
Operating profit	29.4	56.1	13.4	29.1	-48.1%
Operating profit margin	24.4%	22.8%	17.2%	16.2%	-6.6pts
Income before income tax	29.3	55.9	12.9	28.3	-49.4%
Income before income tax margin	24.4%	22.7%	16.6%	15.7%	-7.0pts
Net income	20.9	40.3	8.8	20.2	-49.9%
Net income margin	17.4%	16.4%	11.3%	11.2%	-5.2pts
Dividend per share (JPY)	-	-	-	11 ^{*1}	
Dividends payout ratio	-	-	-	12.5%	

^{*1} Regarding the dividend per share for the year ending March 31, 2024, we plan to pay the amount for half a year as a year-end dividend, given the listing was in the second half of the year.

FY2024/3 Earnings Forecast: Factors for Change

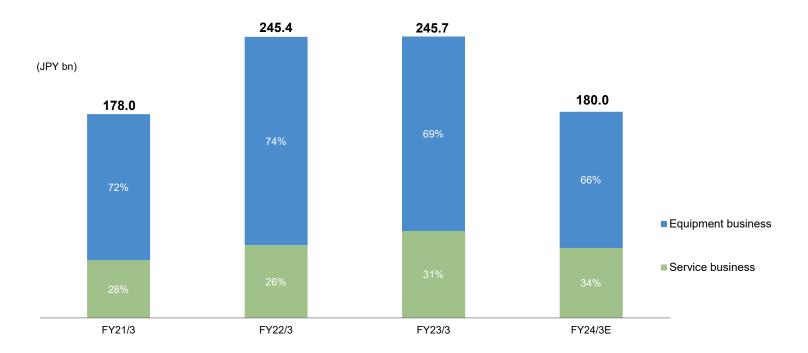
Equipment revenue is expected to decline due to the impact of restrained investment by some device manufactures. Adjusted operating profit will decrease due to a decline mainly in equipment revenue.





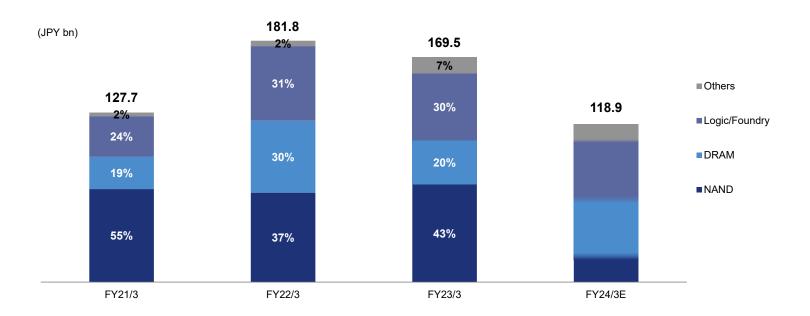
Revenue Forecast by Business

For FY24/3, a decline in equipment revenue will result in temporary increase in the revenue composition ratio for service.



Revenue Forecast by Application (Equipment only)

For FY24/3, revenue composition ratio for Logic/Foundry is expected to increase due to restrained investment in memory and active investment in mature nodes.







Highlight

Consolidated Results for 2Q FY24/3

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- Our 1H results saw a decrease in revenue and profits, but 2Q results improved significantly QoQ.

Consolidated Earnings Forecast for FY24/3

■ 1Q was sluggish; recovery expected to start in 2Q with further rebound anticipated in 3Q and 4Q. Robust investment for mature nodes to support our revenue. No changes to the previous forecast.

Medium- to Long-term Business Strategies and Objectives

■ We continue R&D investment and Capex for medium- to long-term growth, to respond to the changes in the market environment and customer needs and further expand our business.

Business Environment

We believe the semiconductor device and WFE markets likely have already bottomed out and will start to recover in and after CY2024

Semiconductor Device Market

In the medium- to long-term, significant growth is expected due to expansion of data centers by expanding 5G, AI, IoT, and DX, and investment in reducing environmental impact (GX).

■ WFE Market

Semiconductor device makers continue to invest in cutting-edge product development.

The market is expected to be mostly flat in CY24 and grow to USD110-120 bn in the next few years.

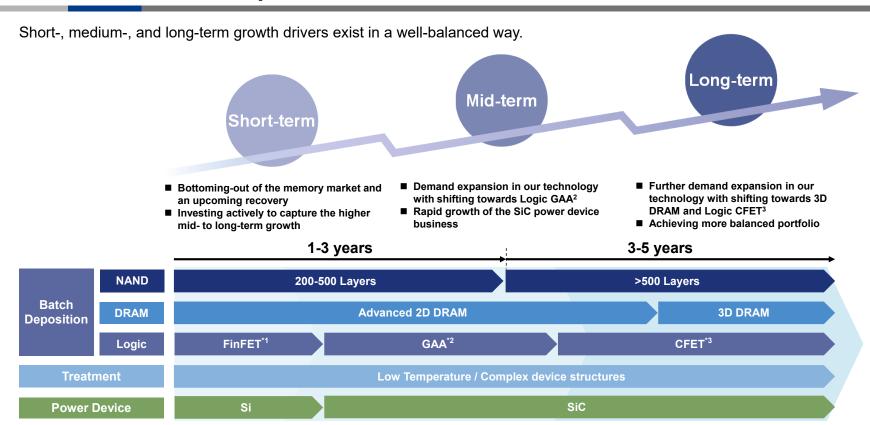
Demand for high-value-added semiconductor manufacturing equipment is expected to increase as semiconductor devices become more complex.

Equipment Revenue Forecast in FY24/3 and FY25/3

- Although equipment revenue in FY24/3 are expected to decline significantly compared to FY23/3, we anticipate growth that exceeds WFE in FY25/3.
- Trends by application

NAND	Expected to recover in and after the second half of FY25/3.
DRAM	Most stable orders and sales are expected. Mass production of cutting-edge devices is expected to recover.
Logic/Foundry	In the short-term, mature nodes for China will lead demand, after which the balance is expected to improve as global demand for cutting-edge products starts to increase.
Others	Rapid growth of SiC power devices is expected to contribute.

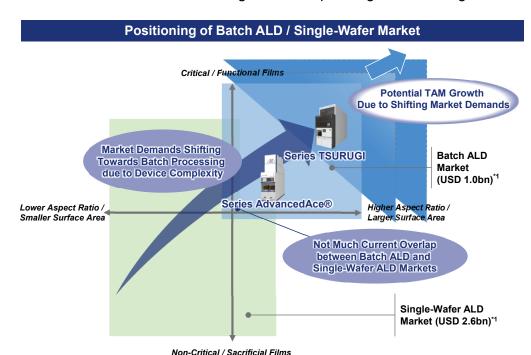
Our Growth Roadmap



*1 Fin Field-Effect Transistor *2 Gate All Around *3 Complimentary Field Effect Transistor

Batch ALD Market Outlook

Batch ALD market expands as devices become more complex. The demand for batch ALD is expected to increase not only in NAND but also in DRAM and Logic, while separating from the single-wafer ALD market.



Demand Outlook for Batch ALD by Application

NAND

 The number of processes that require batch ALD will continue to increase due to further layering of 3D NAND

DRAM

- Demand for cutting-edge deposition, where batch deposition is a specialty, has expanded
- The number of processes that require batch ALD has been expanded further due to the shift to 3D DRAM

Logic/Foundry

 The number of processes that require batch ALD has been expanded as device structures become more complex and three-dimensional by shifting from FinFET to GAA and CFET.



^{*1} Kokusai estimate based on public information and internal sales data

Mid- to Long-Term Objectives

We aim to expand R&D investments and enhance manufacturing and development systems to increase sales growth and profit expansion for the sake of mid- to long-term growth.

	FY22/3	FY23/3	Mid- to Long-Term Objectives
Revenue	JPY245.4 bn	JPY245.7 bn	JPY300-330 bn
Equipment (% Revenue)	74%	69%	70-75%
Service (% Revenue)	26%	31%	25-30%
Gross profit	43.6%	41.0%	> 43.0%
R&D expenses ratio (vs revenue)	4.0%	5.1%	around 6%
Adjusted operating profit margin	32.4%	26.1%	28-30%
(Ref.) WFE assumption	USD90 bn (CY2021)	USD100 bn (CY2022)	USD110-120 bn

Shareholder Return Policy

We aim to provide high shareholder returns, placing top priority on growth investments.

Plan to pay dividends from capital surplus with a target consolidated dividend payout ratio of 20% to 30%

Stable, continuous and proactive return of profits to our shareholders to be an important management issue, while securing the internal reserves necessary for future business development.

Plan to conduct further shareholder return including share buyback once our net cash becomes positive

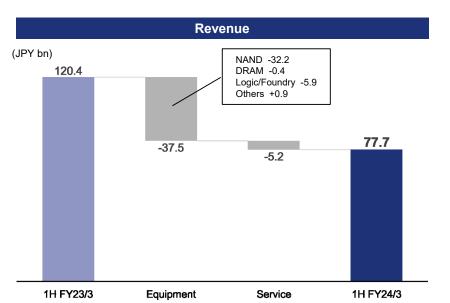
Once our net cash becomes positive, we aim to allocate an amount equivalent to approx. 70% of free cash flow after the redemption of interest-bearing debt towards dividends and share buyback, in order to further improve shareholder profits and capital efficiency.

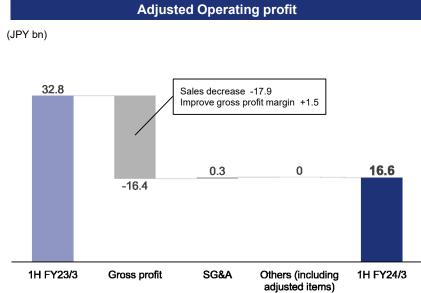
Appendix

1H FY2024/3 Results: Factors for Changes

Restrained investment by some device manufacturers resulted in a decrease in revenue of JPY42.7 bn YoY due to the decrease in revenue for equipment and service.

Decreased revenue led to a decrease in gross profit, with adjusted operating profit down JPY16.2 bn YoY.





Income Statement, R&D Expenses, Capex and D&A expenses

		FY23/3					FY24/3		
(JPY mn)	1Q	2Q	3Q	4Q	Full year	1Q	2Q		
Revenue	56,035	64,385	65,216	60,085	245,721	32,710	44,995		
Gross profit	23,090	27,489	26,359	23,867	100,805	14,275	19,890		
Gross profit margin	41.2%	42.7%	40.4%	39.7%	41.0%	43.6%	44.2%		
Adjusted operating profit	14,700	18,102	17,154	14,295	64,251	5,614	11,035		
Adjusted operating profit margin	26.2%	28.1%	26.3%	23.8%	26.4%	17.2%	24.5%		
Adjusted net income	10,796	12,473	12,193	10,523	45,985	3,782	7,304		
Adjusted net income margin	19.3%	19.4%	18.7%	17.5%	18.7%	11.6%	16.2%		
Operating profit	12,984	16,407	15,527	11,146	56,064	3,990	9,383		
Operating profit margin	23.2%	25.5%	23.8%	18.6%	22.8%	12.2%	20.9%		
Income before income tax	12,901	16,429	15,667	10,898	55,895	3,727	9,145		
Income before income tax margin	23.0%	25.5%	24.0%	18.1%	22.7%	11.4%	20.3%		
Net income	9,605	11,297	11,064	8,339	40,305	2,655	6,158		
Net income margin	17.1%	17.5%	17.0%	13.9%	16.4%	8.1%	13.7%		
R&D expenses	2,688	3,293	2,912	3,532	12,425	2,932	3,023		
Capital expenditures	736	2,853	2,151	828	6,568	5,077	2,071		
Depreciation and amortization	2,529	2,563	2,600	2,612	10,304	2,637	2,671		

Reconciliation of Adjusted Items

			FY23/3			FY24	/3
(JPY mn)	1Q	2Q	3Q	4Q	Full year	1Q	2Q
Operating profit	12,984	16,407	15,527	11,146	56,064	3,990	9,383
Other income	-30	-30	-191	-19	-270	-30	-110
Other expenses	23	88	41	1,410	1,562	45	33
(Adjustments)							
Purchase price allocation amortization	1,592	1,593	1,592	1,592	6,369	1,592	1,592
Stand-alone related expenses	105	16	156	76	353	1	10
Stock-based compensation (except for performance-linked stock compensation)	26	28	29	90	173	16	127
Total adjustments	1,723	1,637	1,777	1,758	6,895	1,609	1,729
Adjusted Operating Profit	14,700	18,102	17,154	14,295	64,251	5,614	11,035
Net income	9,605	11,297	11,064	8,339	40,305	2,655	6,158
Other income	-30	-30	-191	-19	-270	-30	-110
Other expenses	23	88	41	1,410	1,562	45	33
(Adjustments)							
Purchase price allocation amortization	1,592	1,593	1,592	1,592	6,369	1,592	1,592
Stand-alone related expenses	105	16	156	76	353	1	10
Stock-based compensation (except for performance-linked stock compensation)	26	28	29	90	173	16	127
Tax adjustment to total adjustments	-525	-519	-498	-965	-2,507	-497	-506
Adjusted Net Income	10,796	12,473	12,193	10,523	45,985	3,782	7,304

Key Balance Sheet Items

(JPY mn)			End of 4Q FY23/3	End of 1Q FY24/3	End of 2Q FY24/3
Assets	Current Assets	Cash and cash equivalents	106,053	94,493	87,550
	7.000.0	Trade and other receivables	47,477	28,967	33,588
		Inventories	67,197	80,273	86,283
		Other current assets	1,917	1,809	1,213
		Total current assets	222,644	205,542	208,634
	Non-current Assets	Property, plant and equipment	18,775	23,227	24,325
	7.000.0	Goodwill	59,065	59,065	59,065
		Intangible assets	62,968	61,420	59,941
		Other non-current assets	6,811	7,651	8,074
		Total non-current assets	147,619	151,363	151,405
Total Asset			370,263	356,905	360,039

(JPY mn)			End of 4Q FY23/3	End of 1Q FY24/3	End of 2Q FY24/3
Liabilities	Current Liabilities	Loans payable	6,000	6,000	6,750
	Liabilitio	Trade and other payables	41,790	28,982	29,645
		Contract liabilities	28,918	32,068	29,354
		Other current liabilities	21,469	13,875	15,009
		Total current liabilities	98,177	80,925	80,758
	Non-current Liabilities	Loans payable	91,500	91,500	87,750
	Liabilities	Other non-current liabilities	19,705	19,151	19,395
		Total non-current liabilities	111,205	110,651	107,145
	Total Liabilit	ies	209,382	191,576	187,903
Equity	Total Equity		160,881	165,329	172,136
Total Liabili	ties and Equi	ty	370,263	356,905	360,039

	End of 4Q FY23/3	End of 1Q FY24/3	End of 2Q FY24/3
Equity ratio	43.5%	46.3%	47.8%
Debt equity ratio	0.6	0.6	0.6
Net cash (JPY mn)	6,847	-4,659	-8,491

Cash Flow

		FY23/3					FY24/3	
(JPY m	ın) 1Q	2Q	3Q	4Q	Full Year	1Q	2Q	
CF from operating activities	-1,950	22,120	-3,351	13,174	29,993	-7,365	-2,030	
CF from investing activities	-982	-1,657	-2,069	-3,117	-7,825	-5,278	-2,037	
Free CF	-2,932	20,463	-5,420	10,057	22,168	-12,643	-4,067	
CF from financing activities	-120	-2,425	-163	-22,405	-25,113	-167	-3,171	
Cash and cash equivalents at beginning of the quarter	108,399	106,464	124,198	118,403	-	106,053	94,493	
Cash and cash equivalents at end of the quarter	106,464	124,198	118,403	106,053	-	94,493	87,550	

Sustainability Management: Materiality

Identified five materiality to accelerate the solution of issues. Identify the priority issues from subjective and objective perspectives and engage in activities with KPI set for each issue to promote sustainability management

Materiality / Priority Themes		Activity Items				
■ Contribution to society through creativity and innovation						
	Creation of new technologies and new products	Development of advanced underlying technologies and promotion of joint development with external institutions Provision of products, technologies, and services attuned to the VOC1				
	Enhancement of customer satisfaction					
	Enhancement of economic performance	Improvement of business results, investment, etc. and confirmation of the return on investment				
■ Creation of a sustainable society and conservation of the global environment						
Re	Reduction of environmental impact	Reduction of greenhouse gas emissions				
		Thorough management of energy				
		Thorough management of waste and hazardous substances				
		Thorough management of water and wastewater				
	Contribution to the environment through technology and products	Development of environmentally friendly products				
Promotion of sustainable procurement		Strengthening of supply chain management				

Materiality / Priority Themes	Activity Items					
■ Human resources management as a source of innovation						
Respect for diversity of human assets	Promotion of diversity & inclusion					
Development of human resources who learn on their own, think on their own and act on their own	Development of global human resources and securing of excellent human resources					
Maintenance and enhancement of health and safety	Strengthening of occupational health and safety management					
■ Strengthening of the governance system to realize sustainability management						
Ot and the size of account	Strengthening of corporate governance					
Strengthening of governance	Thorough compliance					
Thorough management of major	Strengthening of SCR ² / CR risk countermeasures and BCP					
business risks	Strengthening of information security risk countermeasures and BCP					
Ensuring of management	Timely and appropriate disclosure to internal					
transparency	and external parties					
Respect and consideration of human rights						
Respect for human rights	Promotion of the understanding and awareness of employees about human rights					

^{1:} VOC: Voice of Customer

^{2.} SCR: Super Clean Room

Key Activities for 2H FY2024/3

Business Activities

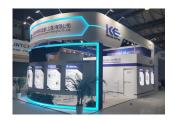
- Earned the 2023 EPIC Distinguished Supplier Award from Intel Corporation (June 23)
- Recognized in Customer Satisfaction Survey by TechInsights as "10 BEST SUPPLIERS" for 26th consecutive years and won "THE BEST SUPPLIERS" award recognizing excellent semiconductor suppliers by product types. (May 23)
- Exhibited at semiconductor industry exhibitions held in various regions, including "SEMICON® China 2023" (June 2023), "SEMICON® West 2023" (July 2023), and "SEMICON® Taiwan 2023" (September 23).
- KOKUSAI ELECTRIC is part of the Integrated Green-niX Consortium for Research and Human-Resource Development (Green-niX), which has been selected for the Ministry of Education, Culture, Sports, Science and Technology's Initiative to Establish Next-generation Novel Integrated Circuits Centers (X-nics). (July 23)











Key Activities for 2H FY2024/3

ESG Initiatives

- Signed the Women's Empowerment Principles (WEPs), which offer guidance to businesses actively promoting women's empowerment in the workplace. (April 23)
- Received "Kurumin Certification" from the Minister of Health, Labour and Welfare, recognizing our initiatives to support childcare. (July 23)
- Held Open-Air Environmental Classes at nursery facilities as part of local contribution activities. (June 23)
- Sponsored the "Owara Kaze no Bon" festival in Yatsuo, Toyama City, where the Toyama Technology & Manufacturing Center is located. (September 23)
- Enhanced the "Compliance Whistleblower System" on the company website to strengthen compliance. (June 23)







